#### 10/30/2015 503548262

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
YEE-CHIA YEO	06/22/2015
CHIH CHIEH YEH	06/12/2015
CHIH-HSIN KO	06/12/2015
CHENG-HSIEN WU	06/12/2015
LIANG-YIN CHEN	06/16/2015
XIONG-FEI YU	06/16/2015
YEN-MING CHEN	06/16/2015
CHAN-LON YANG	06/16/2015

## **RECEIVING PARTY DATA**

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.		
Street Address:	s: NO. 8, LI-HSIN RD. 6		
Internal Address:	SCIENCE-BASED INDUSTRIAL PARK		
City:	HSIN-CHU		
State/Country:	TAIWAN		
Postal Code:	300-77		

### **PROPERTY NUMBERS Total: 1**

Property Type	Number	
Application Number:	14870946	

# **CORRESPONDENCE DATA**

Fax Number: (972)732-9218

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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Email: docketing@slater-matsil.com **Correspondent Name:** SLATER & MATSIL, LLP Address Line 1: 17950 PRESTON RD.

Address Line 2: **SUITE 1000** 

Address Line 4: DALLAS, TEXAS 75252

ATTORNEY DOCKET NUMBER:	TSM15-0146
NAME OF SUBMITTER:	WENDY SAXBY

PAIENI **REEL: 036925 FRAME: 0479** 503548262

SIGNATURE:	/Wendy Saxby/
DATE SIGNED:	10/30/2015
Total Attachments: 2	
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source=4BV5732#page2.tif	

PATENT REEL: 036925 FRAME: 0480

ATTORNEY DOCKET NO. TSM15-0146

#### **ASSIGNMENT**

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made; and

WHEREAS, Taiwan Semiconductor Manufacturing Company, Ltd. ("Assignee"), a corporation organized and existing under the laws of Taiwan, the Republic of China, with its principal office at No. 8, Li-Hsin Rd. 6 Science-Based Industrial Park, Hsin-Chu 300-77 Taiwan, R.O.C., is desirous of acquiring my entire right, title and interest in and to said invention, and to said application and any Letters Patent that may issue thereon in the United States and all other countries throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to said Assignee, its successors and assigns, my entire right, title and interest in and to said invention and in and to said application and all patents which may be granted therefor, and all future non-provisional applications including divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner for Patents to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to said Assignee, as assignee of my entire right, title and interest. I declare that I have not executed and will not execute any agreement in conflict herewith.

I also hereby sell and assign to Assignee, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including, but not limited to, the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said Assignee, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention or the file history thereof, and at the expense of said Assignee, its legal representatives, successors, or assigns, will testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said Assignee, its legal representatives, successors, and assigns, to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year,

TITLE OF INVENTION	Multiple Gate Field-Effect Transistors Having an Oxygen-Scavenged Gate Stack			
SIGNATURE OF INVENTOR AND NAME	Yudi yu.	Chil chiel 76h	Chih-Hsin Ko	Cheng-Hsien Wu
	Yee-Chia Yeo	Chih Chieh Yeh	Chih-Hsin Ko	Cheng-Hsien Wu
DATE	2015/6/22	2015611	2015.6.12	2015.6.12
RESIDENCE	Hsin-Chu City, Taiwan	Taipei City, Taiwan	Fongshan City, Talwan	Hsin-Chu, Taiwan

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Assignment

ATTORNEY DOCKET NO. TSM15-0146

#### **ASSIGNMENT**

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made; and

WHEREAS, Taiwan Semiconductor Manufacturing Company, Ltd. ("Assignee"), a corporation organized and existing under the laws of Taiwan, the Republic of China, with its principal office at No. 8, Li-Hsin Rd. 6 Science-Based Industrial Park, Hsin-Chu 300-77 Taiwan, R.O.C., is desirous of acquiring my entire right, title and interest in and to said invention, and to said application and any Letters Patent that may issue thereon in the United States and all other countries throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to said Assignee, its successors and assigns, my entire right, title and interest in and to said invention and in and to said application and all patents which may be granted therefor, and all future non-provisional applications including divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner for Patents to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to said Assignee, as assignee of my entire right, title and interest. I declare that I have not executed and will not execute any agreement in conflict herewith.

I also hereby sell and assign to Assignee, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including, but not limited to, the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said Assignee, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention or the file history thereof, and at the expense of said Assignee, its legal representatives, successors, or assigns, will testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said Assignee, its legal representatives, successors, and assigns, to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year;

TITLE OF INVENTION	Multiple Gate Field-Effect Transistors Having an Oxygen-Scavenged Gate Stack			
SIGNATURE OF INVENTOR AND NAME	Wang Yim Man	ywrighe!	'(on-Mmy Chen	楊建備
	Liang-Yin Chen	Xiong-Fei Yu	Yen-Ming Chen	Chan-Lon Yang
DATE	6/6/2015	6/16/2015	6/16'15	6/6. 2015
RESIDENCE	Hsin-Chu, Taiwan	Hsin-Chu, Taiwan	Chu-Pei City, Taiwan	Hsin-Chu, Taiwan

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Assignment

PATENT REEL: 036925 FRAME: 0482